



LED

GooLED

GooLED-PHI-11080 Pin Fin Heat Sink Φ 110mm for Philips

Features VS Benefits

- * The GooLED-PHI-11080 Philips Pin Fin LED Heat Sinks are specifically designed for luminaires using the Philips LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 2,500 to 7,000 lumen.
- * Thermal resistance range R_{th} 1.14°C/W.
- * Modular design with mounting holes foreseen for direct mounting of Philips LED engines.
- * Diameter 110.0mm - standard height 80.0mm, Other heights on request.
- * Forged from highly conductive aluminum.



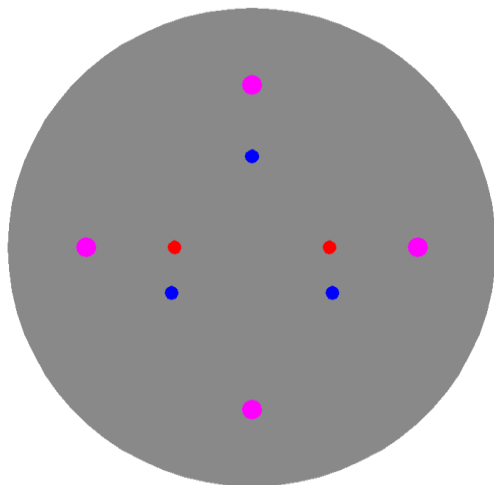
Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of Philips COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.

PHILIPS



LEDiL



Philips LED Modules directly Mounting Options

Philips Fortimo SLM LED modules name:

- Fortimo SLM C xxx 1205 L13 2024 G6;
- Fortimo SLM C xxx 1208 L15 2024 G6;
- Fortimo SLM C xxx 1211 L19 2828 G6;
- Fortimo SLM C xxx xx 1205 L13 2024 G6;
- Fortimo SLM C xxx xx 1208 L13 2024 G6;
- Fortimo SLM C xxx xx 1208 L15 2024 G6;
- Fortimo SLM C xxx xx 1211 L19 2828 G6;

NO`1: With the Zhaga Book 3 standard, Red indicator marks.

NO`2: Blue indicator marks.

Direct mounting with machine screws M3x6.5mm.

With the LEDiL products:

- Stella Series: FN14xxx-xx; FN15xxx-xx;
- Stella Series mounting hole for the pink indicator marks
- Ronda series: FN15xxx;
- Olivia series: FN14828-M; FN14637-S;

Mounting Options and Drawings & Dimensions

Example:GooLED-PHI-11080-B-1,2

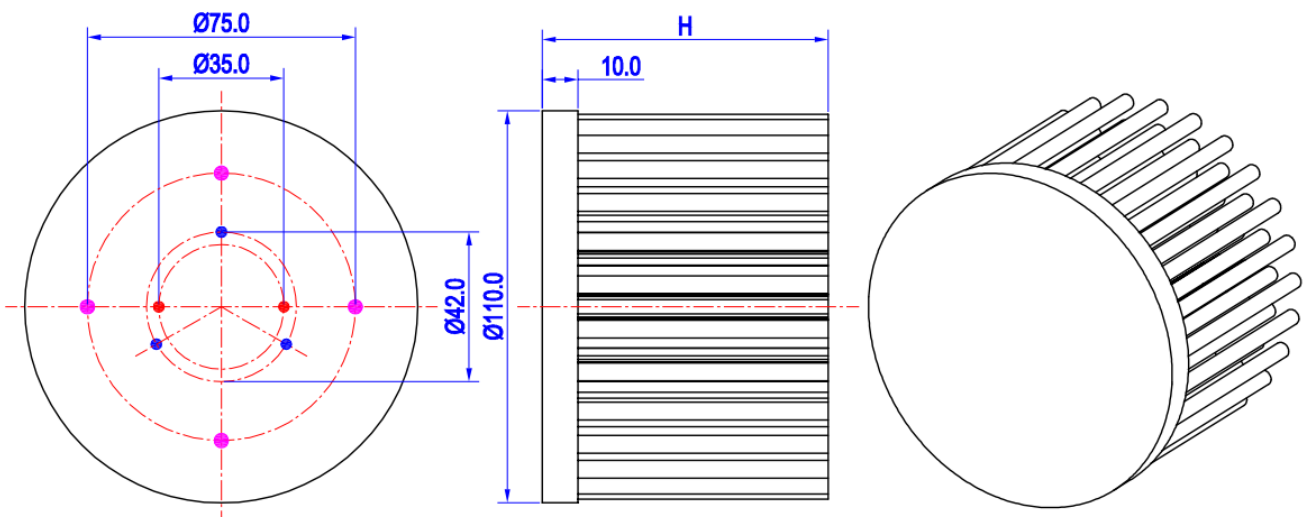
Example:GooLED-PHI-110 **1** - **2** - **3**

- 1** Height (mm)
- 2** Anodising Color
B-Black
C-Clear
Z-Custom
- 3** Mounting Options - see graphics for details Combinations available
Ex.order code - 12
means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	LEDiL products			THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
			Stella Series	Olivia series	Ronda series			
N	/	None	None	None	None	None	None	
1	Fortimo SLM	/	FN14xxx-xx; FN15xxx-xx;	FN14828-M; FN14637-S;	FN15xxx;	M3	6.5mm	35.0mm/ 2-@180° (Zhaga book 3)
2						M3	6.5mm	42.0mm/ 3-@120°
3	LEDiL Lens	/	Stella Series	/	/	M4	8.5mm	75.0mm/ 4-@90°



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GooLED-PHI-11080 Pin Fin Heat Sink $\Phi 110\text{mm}$ for Philips

The product data table

	Model No.	GooLED-PHI-11080
	Heatsink Size	$\Phi 110 \times H 80\text{mm}$
	Heatsink Material	AL1070
	Finish	Black Anodized
	Weight (g)	617.0
	Dissipated power (T _{hs-amb} , 50°C)	44.0 (W)
	Cooling surface area (mm ²)	129119
	Thermal Resistance (R _{hs-amb})	1.14 (°C/W)

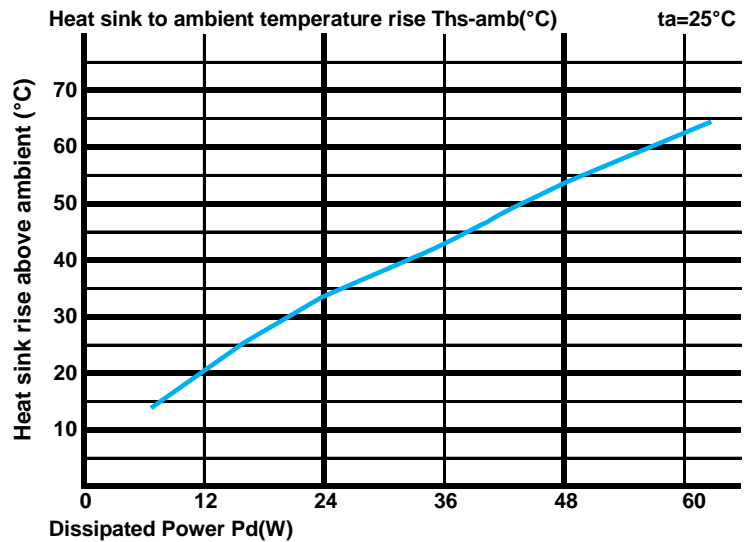
The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

* To calculate the dissipated power please use the following formula: $P_d = P_e \times (1 - \eta_L)$.

Pd - Dissipated power ; Pe - Electrical power ; η_L = Light efficiency of the LED module;

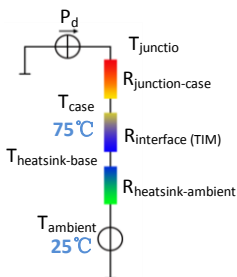
Dissipated Power Pd(W)	Pd = Pe x (1- η_L)	Heat sink to ambient thermal resistance R _{hs-amb} (°C/W)	Heat sink to ambient temperature rise T _{hs-amb} (°C)
		GooLED-PHI-11080	
12.0		1.67	20.0
24.0		1.38	33.0
36.0		1.17	42.0
48.0		1.10	53.0
60.0		1.03	62.0



*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow.

Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (T_{hs} - T_a) / P_d$

θ - Thermal Resistance [°C/W] ; T_{hs} - Heatsink temperature ; T_a - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is R_{junction-case}, the thermal resistance of the TIM outside the package is R_{interface (TIM)} [°C/W], the thermal resistance with the heat sink is R_{heatsink-ambient} [°C/W], and the ambient temperature is T_{ambient} [°C].

*Thermal resistances outside the package R_{interface (TIM)} and R_{heatsink-ambient} can be integrated into the thermal resistance R_{case-ambient} at this point. Thus, the following formula is also used:

$$T_{\text{junction}} = (R_{\text{junction-case}} + R_{\text{case-ambient}}) \cdot P_d + T_{\text{ambient}}$$